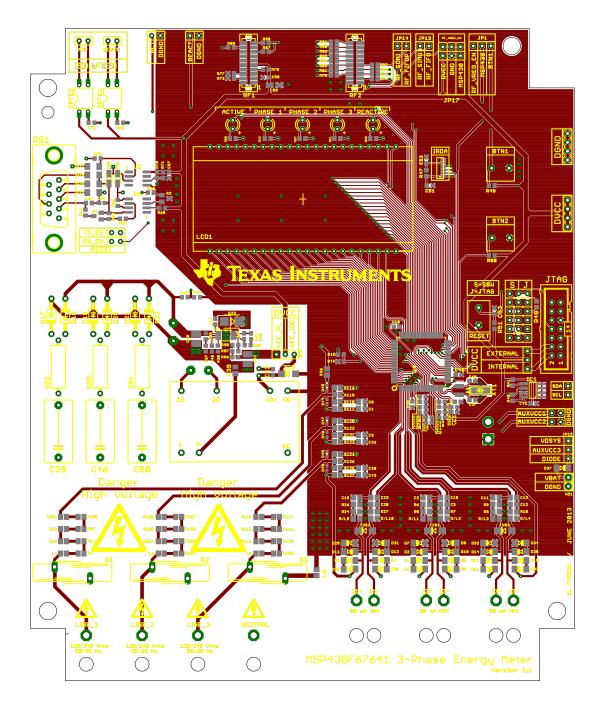
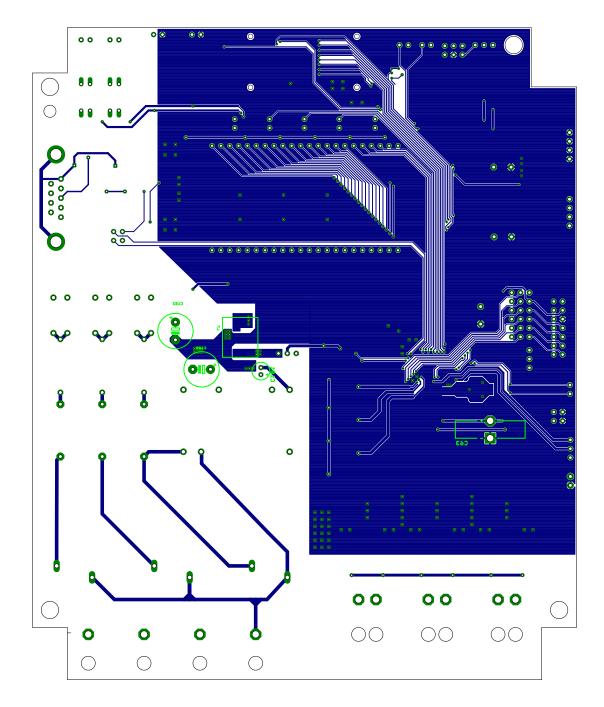
## TIDM-3PH-ENERGY5-ESD (EVM430-F67641 TOP LAYER)



## TIDM-3PH-ENERGY5-ESD (EVM430-F67641 BOTTOM LAYER)



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